Low-Temperature Spin Seebeck Effect in the Helimagnetic Insulator Cu$_2$OSeO$_3$

Artem Akopyan
University of Miami, a.akopyan@outlook.com

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LOW-TEMPERATURE SPIN SEEBECK EFFECT IN THE HELIMAGNETIC INSULATOR Cu$_2$OSeO$_3$

By

Artem Akopyan

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LOW-TEMPERATURE SPIN SEEBECK EFFECT IN THE HELIMAGNETIC INSULATOR Cu$_2$OSeO$_3$
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The rapidly growing fields of spin caloritonics and magnon spintronics have brought on a surge of interest in magnetic and thermal transport properties of magnetic insulators. Here we present low-temperature measurements of thermal conductivity and spin Seebeck effect in the helimagnetic insulator Cu₂OSeO₃ as functions of temperature, magnetic field, and crystallographic orientation. This compound hosts novel spin phases with long-period spin modulations, and its magnon thermal conductivity (~70 W/mK near 5 K) is the largest of any known ferro- or ferrimagnetic insulator. The magnetic field dependencies of thermal conductivity and spin Seebeck effect reveal novel aspects of phonon and magnon transport in chiral spin phases, like anisotropic scattering and domain structure. Analysis of the temperature dependence of spin Seebeck effect provides insight into the relevant time and length scales involved in thermally driven spin current phenomena.
DEDICATION

To my wife Ekaterina and daughter Arya
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Chapter 1. Introduction

This chapter will summarize the historical development of the field of spin caloritronics and provide brief phenomenological descriptions of related concepts and effects.

1.1 Spin Hall Effect

![Spin Hall Effect Diagram](image)

Figure 1.1 (from Ref. [1]). (a) Spin Hall effect: charge current (red arrow) induced a transverse spin current (yellow arrow), (b) inverse spin Hall effect: spin current (yellow arrow) induced a transverse charge current (red arrow).

Spin Hall effect refers to a conversion of a charge current density $J_c$ into a transverse spin current density $J_s$ as a result of spin-orbit interaction. The inverse effect is also possible and can be used to detect spin currents

$$\vec{E}_{ISHE} = \frac{2e}{h} \theta_{SH} \vec{J}_s \times \vec{\sigma}.$$  \hspace{1cm} (1.1)

where $\theta_{SH}$ is the spin Hall angle, $\vec{J}_s$ is the spin current, and $\vec{\sigma}$ is the spin direction.

1.2 Seebeck Effect

The first thermoelectric effect, the Seebeck effect, was discovered by Thomas Seebeck in 1821 [2] and involved interactions between heat currents and charge currents. Seebeck effect refers to a generation of a charge current in a material in response
to a temperature gradient. Microscopically, under open circuit conditions charge carriers at the hot end diffuse towards the cold end until the electric field within the material is established through carrier accumulation and equilibrium is reached (Figure 1.2). Then the Seebeck coefficient $S$ is defined as

$$S = -\frac{V_{SE}}{\Delta T}.$$  

(1.2)

Figure 1.2 (from Ref. [1]). Illustration of Seebeck effect.

This concept found applications in many modern devices like thermometers, coolers, power generators, waste heat recyclers and many more.

### 1.3 Spin Seebeck Effect

In spin Seebeck effect (SSE) heat currents interact with spin waves (magnons) and inverse spin Hall effect is used to detect these thermally driven spin currents. The simplest system involves a ferromagnetic insulator in interfacial contact with a paramagnetic, heavy metal. Two configurations are possible: longitudinal and transverse (Figure 1.3). In the more straight forward longitudinal configuration, when magnetization is perpendicular to the temperature gradient, the temperature gradient produces a magnon spin current that results in magnon accumulation at the cold end. Experimentally, the spin accumulation is detected by a placement of a thin paramagnetic film on the surface perpendicular to the
heat flow. Magnon accumulation pumps spin current into the film, where it is converted to an electrically detectable charge current via the inverse spin Hall effect [1], [4].

In the transverse configuration (Figure 1.3b), the temperature gradient is applied along the x direction. In order to generate an ISHE voltage, the ferromagnet has to be magnetized along the direction of the gradient. Therefore, the anomalous Nernst effect in the ferromagnet vanishes, since magnetization and ΔT are collinear, enabling an unperturbed detection of the transverse SSE in various magnetic materials. The characteristic property of the transverse SSE is the sign reversal of the thermally generated spin voltage between the lower and higher temperature ends of the ferromagnet.

Figure 1.3 (from Ref.[1], [4]). Two possible SSE configurations.

Spin Seebeck was first experimentally observed by Uchida et al. in 2008 [3]. The measurements were done on thick permalloy (Ni81Fe19) films with platinum strips for SSE detection in the transverse configuration. Subsequently, spin Seebeck was observed in insulators [5] and semiconductors [6].
Xiao et al. [7] provided the first theoretical description of SSE bases on interfacial spin pumping driven by the difference between phonon temperature and magnon temperature. Agrawal et al. [8] directly measured the temperature of short wavelength magnons in YIG with Brillouin light scattering technique. They observed a difference between phonon and magnon temperatures that is much smaller than the one predicted by Xiao et al. Kehlberger et al. [93] reported that the thickness dependence of spin Seebeck effect in YIG films correlated with the bulk magnon mean free path, suggesting that thermally driven magnons in the bulk, rather than the interface, are responsible for spin Seebeck effect. This origin of SSE has been corroborated by recent theoretical and experimental work [68].
Chapter 2. Theoretical Background

This chapter will present brief summaries of theories and models used in the analysis of thermal conductivity and spin Seebeck data in Chapters 5 and 6. We will limit this overview only to physical phenomena relevant to magnetic insulators, where the only energy carriers and phonons and magnons.

2.1 Lattice Thermal Conductivity

2.1.1 Phonons

A phonon is a quantum mechanical representation of a vibrational mode of atoms in a periodic lattice. Phonons are the primary quasiparticles that are responsible for thermal conductivity of the lattice, so they play a central role in heat transport of insulators [9]. Phonons are bosons and obey Bose-Einstein statistics with the equilibrium distribution

\[ n_k^0 = \frac{1}{\exp\left(\frac{\hbar \omega_k}{k_B T}\right) - 1}. \]  

(2.1)

Phonon group velocity is given by \( \mathbf{v}_k = \nabla_k \omega_k \) and the dispersion relation is approximately linear for small wave numbers, \( \omega_k = v_k k \).

In the presence of a temperature gradient, the distribution drifts away from equilibrium at a rate

\[ \left(\frac{\partial n_k}{\partial t}\right)_{\text{drift}} = -\mathbf{v}_k \cdot \nabla n_k = -\mathbf{v}_k \cdot \nabla T \frac{dn_k}{dT}. \]  

(2.2)

and in the steady state must be opposite of the change due to phonon scattering, resulting in Boltzmann equation
\[
\left( \frac{\partial n_k}{\partial t} \right)_{\text{scattering}} - \mathbf{v}_k \cdot \nabla T \frac{dn_k}{dT} = 0. \tag{2.3}
\]

Two approximations are used to solve this equation. First, only the \( n_k^0 \) contribution is kept in

\[
\frac{\partial n_k}{\partial T} \approx \frac{\partial n_k^0}{\partial T}. \tag{2.4}
\]

Secondly, the relaxation time approximation assumes that when the deviations from the equilibrium are small, the scattering term can be expressed by

\[
\left( \frac{\partial n_k}{\partial t} \right)_{\text{scattering}} = \frac{n_k^0 - n_k}{\tau_k} = -\frac{\delta n_k}{\tau_k}, \tag{2.5}
\]

where \( \tau_k \) is the relaxation time and \( \delta n_k \) is the phonon number in excess of equilibrium. With these approximations, the Boltzmann equation describing phonon dynamics assumes the form

\[
-\tau_k \mathbf{v}_k \cdot \nabla T \frac{\partial n_k^0}{\partial T} = \delta n_k. \tag{2.6}
\]

Substituting the result into the expression for the heat current due to a flow of phonons gives (summation over phonon branches is implied)

\[
\hat{J}_{\mathbf{q},\mathbf{p}} = \frac{1}{(2\pi)^3} \int d^3 k \delta n_k \hbar \omega_k \mathbf{v}_k = -\frac{1}{(2\pi)^3} \int d^3 k \hbar \omega_k \mathbf{v}_k^2 \tau_k \frac{\partial n_k^0}{\partial T} \nabla T
\]

\[
= -\kappa_L \nabla T. \tag{2.7}
\]

Thus, assuming linear dispersion \( \omega_k = v_k k \), averaging over the phonon branches (\( \nu \) – averaged velocity), and using the maximum frequency of the vibrational spectrum (given by Debye temperature \( \theta_D \)) one obtains the phonon thermal conductivity
\[
\kappa_L = \frac{k_B}{2\pi^2 v} \int_0^{k_B \theta_D / \hbar} \omega^2 \tau(\omega, T) \left( \frac{\hbar \omega}{k_B T} \right)^2 \frac{\frac{\hbar \omega}{e^{\frac{\hbar \omega}{k_B T}} - 1}}{d\omega}.
\] (2.8)

With an introduction of a dimensionless variable \( x = \frac{\hbar \omega}{k_B T} \) this becomes

\[
\kappa_L = \frac{k_B}{2\pi^2 v} \left( \frac{k_B T}{\hbar} \right)^3 \int_0^{\theta_D / T} \tau(x, T) \frac{x^4 e^x}{(e^x - 1)^2} dx
\]

\[= \frac{1}{3} \int_0^{\theta_D / T} C(x) v^2 \tau(x) dx,
\]

where

\[
C_p(x) = \frac{3k_B}{2\pi^2 v^3} \left( \frac{k_B T}{\hbar} \right)^3 \frac{x^4 e^x}{(e^x - 1)^2}
\] (2.10)

is the contribution to heat capacity from phonons of frequency \( \omega = \frac{k_B T x}{\hbar} \). In this relaxation time approximation, all scattering processes are treated on equal grounds in the context of Matthiessen’s rule that says that rates due to different scattering mechanisms \( \tau_i^{-1} \) contribute equally to the total relaxation rate

\[
\tau^{-1} = \sum_i \tau_i^{-1}.
\] (2.11)

### 2.1.2 Phonon Scattering Mechanisms

**Intrinsic Scattering**

For real crystal lattices the harmonic approximation is not exactly valid, therefore, one needs to consider the effects of anharmonic forces, that play a crucial role in the theory of thermal transport. Indeed, in a perfectly harmonic, defect-free lattice, there would be no scattering mechanisms for phonons, resulting in an infinite thermal conductivity. Anharmonicity introduces phonon-phonon scattering into the picture. Generally, only
three-phonon processes are relevant at low temperatures. Scattering theory, first introduced by Pierels [9], finds that energy and momentum conservation considerations imply the rate of change of phonon distribution due to scattering event between three phonons with frequencies and reduced wave vectors in the first primitive cell $\omega_l$ and $\vec{k}_l$ vanishes, unless the following conditions are satisfied (in the case of coalescence)

$$\omega_1 + \omega_2 = \omega_3$$

and

$$\vec{k}_1 + \vec{k}_2 = \vec{k}_3, \text{ or } \vec{k}_1 + \vec{k}_2 = \vec{k}_3 + \vec{K}$$

(2.12)

where $\vec{K}$ is the reciprocal lattice vector. Eq. (2.12) suggests that there are two distinct processes, although this distinction depends on the choice of the primitive cell [10]. Historically, the $\vec{k}$ conserving process are called normal processes, while the non-conserving processes are called Umklapp processes. Peierls has also shown that normal processes alone (i.e. no other scattering is present) do not completely relax the phonon distribution and, therefore, produce a non-zero heat flux even in the absence of a thermal gradient, but together with Umklapp processes they shape the thermal conductivity throughout the temperature range. Normal processes help to establish equilibrium between low and high frequency phonons, ultimately, slightly changing the phonon distribution and having a moderate effect on the overall thermal conductivity at low temperatures in some models. Recent ab-initio first principle calculations reveal that even at room temperatures a big fraction of thermal conductivity is attributable to low frequency phonons that scatter though normal processes [11].

The derivation of the intrinsic scattering processes is based on the treatment of the anharmonic interaction in the framework of first Born approximation and the calculation
of transition probabilities between two phonon states and, therefore, rates of change of the phonon distribution [12].

In general, the scattering rate for normal processes has the form

\[ \tau_N^{-1} = A \omega^{\alpha_N} T^{\beta_N} \]  

(2.13)

where \( A \) is a free parameter, \( \alpha_N = 2, \beta_N = 3 \) at low temperatures, and \( \alpha_N = 2, \beta_N = 1 \) in the high temperature limit [13]. Various authors calculated or derived from experimental data the following form for the Umklapp scattering rate

\[ \tau_u^{-1} = B \omega^{\alpha_u} T^{\beta_u} \exp \left( -\theta_D / bT \right) \]  

(2.14)

where \( B \) and \( b \) are free parameters, \( \alpha_u = 2, \beta_u = 3 \) [14], [15].

**Extrinsic Scattering**

Phonons can scatter from crystal boundaries, lattice defects and impurities, as well as other quasiparticles participating in thermal transport.

The scattering rate of phonons due to crystal boundaries of a rod-like sample is due to the original work of Casimir [16]

\[ \tau_B^{-1} = \frac{v}{l_0} = \frac{v}{2\sqrt{a/\pi}}, \]  

(2.15a)

\[ \kappa_L = \left( \frac{2\pi^2}{15} \right) \left( \frac{k_B T}{\hbar} \right)^3 k_B v l_{ph} \]  

(2.15b)

where \( l_0 \) is the transverse dimension of the rod, \( a \) is the cross-sectional area, \( l_{ph} \) – phonon mean-free path. Phonon thermal conductivity in boundary limited regime (ballistic transport) is given in Equation 2.15b.

The expression for the scattering from impurities or point defects was derived by Klemens [17]
\[
\tau_j^{-1} = n \frac{V_0}{4\pi v^3} \omega^4 \left\{ \left( \frac{\Delta M}{M} \right)^2 + 2 \left[ \frac{\Delta F}{F} - 13.44 \left( \frac{\Delta R}{R} \right)^2 \right] \right\},
\]

(2.16)

where \( n \) is the impurity concentration, \( V_0 \) is the unit cell volume, \( \Delta M \) is the mass difference between host and impurity atom, \( M \) is the average molecular mass, \( \Delta F \) is the change in the force constant, \( \Delta R \) is the change in the nearest neighbor distance. In the case of vacancies, Eq. (2.16) reduces to

\[
\tau_v^{-1} = n \frac{9a^3}{4\pi v^3} \omega^4 \left( \frac{M_v}{M} \right)^2,
\]

(2.17)

where \( a \) is the atomic radius and \( M_v \) is the atomic mass of the vacant atom [18]. This concludes our overview of most common phonon scattering mechanisms; other mechanisms not included here are isotope scattering, sheet like defects, grain boundaries, resonant spin scattering, etc. Phonon-magnon interactions will be discussed in more detail in Section 2.2.2.

### 2.1.3 Beyond the Relaxation Time Approximation

J. Callaway introduced a model for lattice thermal conductivity that makes an effort to better account for the effects of normal scattering processes on thermal conductivity at low temperatures [19]. In his model, Callaway follows Ref. [20] and uses the concept of a displaced (or “flowing equilibrium”) distribution

\[
n^*_k = \left[ \exp \left( \frac{\hbar \omega_k - \vec{\lambda} \cdot \vec{k}}{k_B T} \right) - 1 \right]^{-1} = n_k^0 + \frac{\vec{\lambda} \cdot \vec{k}}{k_B T} \left( e^{\frac{\hbar \omega_k}{k_B T}} - 1 \right)^2.
\]

(2.18)

This is the distribution normal processes relax to in the absence of other scattering. The rate of change of the distribution due to collisions then takes the form
\[
\left( \frac{\partial n_k}{\partial t} \right)_{\text{scattering}} = \frac{n_k^0 - n_k}{\tau_k^\eta} + \frac{n_k^* - n_k}{\tau_k^\nu},
\]
(2.19)

where \( \tau_k^\eta \) is the relaxation rate due to normal processes, \( \tau_k^\nu \) is the sum of all momentum non-conserving rates, and the combined relaxation rate is

\[
\tau_c^{-1} = \tau_N^{-1} + \tau_u^{-1}.
\]
(2.20)

Substituting this in the Boltzmann equation (Eq. 2.3) and accounting for the correction by P. Allen [21] leads to the final expression for lattice thermal conductivity

\[
\kappa_L = \frac{k_B}{2\pi^2 v} \left( \frac{k_B T}{\hbar} \right)^3 \int_0^{\theta_D/T} \tau_c(x, T) \frac{x^4 e^x}{(e^x - 1)^2} dx \left[ 1 + \frac{\tau_c(x, T)/\tau_N(x, T)}{\tau_c(x, T)/\tau_u(x, T)} \right],
\]
(2.21)

where

\[
\bar{f}(T) = \int_0^{\theta_D/T} f(x, T) \frac{x^4 e^x}{(e^x - 1)^2} dx / \int_0^{\theta_D/T} \frac{x^4 e^x}{(e^x - 1)^2} dx.
\]
(2.22)

2.2 Magnon Thermal Conductivity

2.2.1 Magnons

A magnon is a quantum mechanical representation of a collective excitation of spins (spin wave) in a periodic lattice. Like phonons, magnons obey the Bose-Einstein statistics (Eq. 2.1), but their dispersion relation is approximately quadratic for small wave numbers, \( \omega_k = (D/\hbar)k^2 \), where \( D \) is the spin-wave stiffness. The presence of magnons in a magnetic insulator can significantly affect its thermal conductivity as magnons can carry energy and contribute to the total thermal conductivity or reduce it by scattering phonons. Following the transport theory outlined in Section 2.1.1, the thermal conductivity due to non-equilibrium magnons driven by a temperature gradient can be calculated by
\[
\kappa_m = \frac{k_B}{6\pi^2} \int_0^{k_m} k^2 \tau_k \nu_k^2 \frac{x^2 e^x}{(e^x - 1)^2} dk
\]

(2.23a)

\[
\kappa_m = \frac{\zeta(3) k_B^3 l_m}{4\pi^2 \hbar D} T^2
\]

(2.23b)

where \( k_m \) is the maximum magnon wave number under the assumption of a spherically symmetric dispersion, \( \tau_k \) is the relaxation time of magnons with wave number \( k \), and \( x = \frac{\hbar \omega}{k_B T} \). In the boundary-limited regime, magnon heat conduction reduces to Eq. 2.23b [22].

Using an approximation for the magnon dispersion relation suitable for large wave numbers \( \omega_k = \omega_Z B (1 - \cos \pi k / 2k_m) \) and introducing a normalized wave number \( q = k / k_m \) [23], the thermal conductivity becomes

\[
\kappa_m = \frac{\omega_Z B k_m k_B}{24} \int_0^1 q^2 \sin^2 \left( \frac{\pi q}{2} \right) \tau_q \frac{x^2 e^x}{(e^x - 1)^2} dq.
\]

(2.24)

### 2.2.2 Magnon Scattering

Theory of magnon interactions in the first Born approximation has been studied in great detail by Akhiezer et. al. in Ref. [24]. They estimate the scattering rates due to normal 3-magnon confluence \( \tau_{3N,c}^{-1} \) and splitting \( \tau_{3N,s}^{-1} \) as well as 4-magnon scattering events \( \tau_{4N}^{-1} \) for a magnon with wavenumber \( k \):

\[
\tau_{3N,c}^{-1}(k) \approx \left( \frac{g \mu_B M_s}{2 \pi \theta_C} \right)^2 \frac{k_B T \theta_C}{\hbar} \frac{\Delta}{\Delta} ak,
\]

(2.25a)

\[
\tau_{3N,s}^{-1}(k) \approx \left( \frac{g \mu_B M_s}{\theta_C} \right)^2 \frac{k_B T}{6\pi \hbar} \left( \frac{\theta_C}{\Delta} \right)^{1/2} \left( \frac{\Delta}{\Delta} - 3 \right)^{1/2},
\]

(2.25b)

\[
\tau_{4N}^{-1}(k) \approx \frac{\theta_C}{\hbar} \left( \frac{k_B T}{\theta_C} \right)^{5/2} (ak)^3,
\]

(2.25c)
where $g$ is the gyromagnetic ratio, $\mu_B$ – Bohr magneton, $M_s$ – saturation magnetization, $a$ – lattice parameter, and $\varepsilon(k) = \Delta + \theta_C (ak)^2$ is the magnon dispersion relation. Forney and Jackle [25] used a similar approach to calculate thermally averaged 3-magnon and 4-magnon normal ($\tau_{3N}^{-1}$, $\tau_{4N}^{-1}$) and Umklapp ($\tau_{3U}^{-1}$, $\tau_{4U}^{-1}$) scattering rates and magnon-impurity scattering rate ($\tau_i^{-1}$):

$$\tau_{3N}^{-1} = 2.6 \frac{k_B}{\hbar} T_d^2 T_e^{-3/2} T^{1/2}, \quad \tau_{4N}^{-1} = 6.1 \times 10^4 \frac{k_B}{S^2 \hbar} T_e^{-3} T^4,$$

$$\tau_{3U}^{-1} = 1.4 \times 10^4 \frac{g k_B}{\hbar} T_d^2 T_e^{-1/2} T^{-1/2} \exp(-12 T_e / T),$$

$$\tau_{4U}^{-1} = \frac{2 k_B}{S^2} T_e^{-1/2} T^3/2 \exp(-12 T_e / T),$$

$$\tau_i^{-1} = 0.4 c \frac{k_B^2}{\hbar} T_e^{-3/2} T^{5/2},$$

where

$$T_d = \left( \frac{g \mu_B}{k_B a^3} \right)^2, \quad T_e = \frac{2 S J}{k_B},$$

and $S$ is the effective spin, $J$ is the exchange coupling constant, and $c$ is the impurity concentration.

### 2.3 Spin Seebeck Effect

This section will outline the bulk magnon spin current theory for the longitudinal spin Seebeck effect [26]-[28]. This approach proposes that the thermal flow of magnons in the bulk of the insulator creates an accumulation of magnons at the interface between a ferromagnetic or ferrimagnetic insulator (FMI) and a metallic layer (ML). The magnon accumulation enables the mechanism of spin pumping into the ML layer. Spin pumping
creates a spin current, which is converted to a charge current by inverse spin Hall effect in the ML layer. The entire process is illustrated in Fig. 2.1.

Figure 2.2 (from Ref. [27]). (a) Schematic illustration of the FMI/ML heterostructure and spin-to-charge current conversion in the ML. (b) Diagram showing temperature gradient induced and back-flow spin currents in the FMI and the pumped spin current in the ML.

Using the approach established in Section 2.1.1, the magnon accumulation at the FMI/ML interface is defined as the density of magnons in excess of equilibrium

$$\delta n_m(\vec{r}) = \frac{1}{(2\pi)^3} \int d^3k [n_k(\vec{r}) - n_k^0].$$  \hspace{1cm} (2.27)

The bulk magnon spin current density with polarization \(z\) is

$$\vec{J}^z = \frac{\hbar}{(2\pi)^3} \int d^3k \vec{v}_k [n_k(\vec{r}) - n_k^0].$$  \hspace{1cm} (2.28)

Using the Boltzmann equation for magnons

$$-\tau_k \vec{v}_k \cdot \nabla n_k(\vec{r}) = n_k(\vec{r}) - n_k^0$$  \hspace{1cm} (2.29)

and plugging into Eq. (2.28) gives two contributions to the spin current \(\vec{J}^z = \vec{J}^{z}_{\nabla T} + \vec{J}^{z}_{\delta n}\), where

$$\vec{J}^{z}_{\nabla T} = -\frac{\hbar}{(2\pi)^3} \int d^3k \tau_k \frac{\partial n_k^0}{\partial T} \vec{v}_k (\vec{v}_k \cdot \nabla T)$$  \hspace{1cm} (2.30)

is due to temperature gradient driven flow of magnons and
\[ J_{\bar{S}\delta n} = -\frac{\hbar}{(2\pi)^3} \int d^3k \tau_k \bar{v}_k [\bar{v}_k \cdot \nabla (n_k(\vec{r}) - n_k^0)] \]  

(2.31)

is due to spatial variation of magnon accumulation. The first contribution evaluates to

\[ J_{SvT} = - \left[ \frac{\hbar}{(2\pi)^3 T} \int d^3k \tau_k v_{k,y}^2 \frac{x e^x}{(e^x - 1)^2} \right] \nabla T, \]  

(2.32)

where \( x = \frac{\hbar \omega_k}{k_B T} \) and the temperature gradient is normal to the interface (in the +y direction).

In order to calculate the contribution to the total spin current due to magnon accumulation, an approximate solution to Boltzmann equation (Eq. 2.29) is required. The magnon distribution function is written as a sum of the equilibrium distribution and a small deviation, \( n_k(\vec{r}) = n_k^0 [1 + \hbar \omega_k g(y)] \), where \( g(y) \) is determined by the solution of the boundary value problem. Substituting into Eq. 2.27, the magnon accumulation becomes

\[ \delta n_m(y) = \frac{1}{(2\pi)^3} \int d^3k \frac{n_k^0}{\hbar \omega_k} g(y). \]  

(2.33)

Plugging the result into Eq. 2.31 gives the spin current due to magnon accumulation

\[ J_{\bar{S}\delta n}(y) = -\hbar D_m \frac{\partial}{\partial y} \delta n_m(y), \]  

(2.34)

where

\[ D_m = \int d^3k \tau_k v_{k,y}^2 n_k^0 \hbar \omega_k \int d^3k n_k^0 \hbar \omega_k \]  

(2.35)

is the magnon diffusion coefficient. Since the magnon accumulation relaxes through magnon-phonon interactions with a relaxation time \( \tau_{mp} \), the conservation of angular momentum implies \( \frac{\partial J_{\bar{S}}}{\partial y} = -\hbar \frac{\delta n_m(y)}{\tau_{mp}} \), resulting in a diffusion equation for magnon accumulation

\[ \frac{\partial^2 \delta n_m(y)}{\partial y^2} = \frac{\delta n_m(y)}{l_m^2}. \]  

(2.36)
where \( l_m = \left( D_m \tau_{mp} \right)^{1/2} \) is the magnon diffusion length. Solving Eq. 2.36 and substituting in Eq. 2.34 results in the spin current density

\[
\vec{j}_{S\delta n}^z(y) = -\hbar \frac{D_m}{l_m} Ae^{\frac{y}{l_m}} + \hbar \frac{D_m}{l_m} B e^{-y/l_m},
\]

(2.37)

where \( A \) and \( B \) are coefficients determined by boundary conditions.

The next step is to calculate the spin current that enters the ML. In the presence of an external magnetic field and spin accumulation at the FMI/ML interface, the magnetization of the FMI \( \vec{M} \) will precess and result in spin pumping into the ML. The resulting spin current is given by

\[
\vec{j}_{S}^{sp}(0^+) = \frac{\hbar}{4\pi M^2} \left( \vec{M} \times \frac{\partial \vec{M}}{\partial t} \right),
\]

(2.38)

where \( g_{r}^{1\uparrow} \) is the real part of spin mixing conductance [29], [30]. This spin current can be expressed in terms of the spin accumulation as follows

\[
\vec{j}_{S}^{p}(0^+) = -\frac{\hbar g_{r}^{1\uparrow}}{4\pi M^2} \sum_{k} \omega_k (m_k^+ m_k^-) \approx \]

(2.39)

\[
-\frac{\gamma \hbar^2 g_{eff}^{1\uparrow}}{2\pi M} \delta n_m(0) \left[ \int d^3k n_k^0 \hbar \omega_k \right] \right].
\]

Here \( m_k^+ \) and \( m_k^- \) are the transverse components of the magnetization of the magnon with wave vector \( k \), \( g_{eff}^{1\uparrow} \) is the real part of the effective spin mixing conductance that accounts for the backflow spin current, and the linear approximation \( m_k^+ m_k^- = 2M\gamma \hbar \delta n_k / V \) has been used. The conservation of angular momentum current imposes boundary conditions that are used to calculate coefficients \( A \) and \( B \) in Eq. 2.37. The resulting spin current at the interface can be shown to take the following approximate form
\[ \tilde{J}_S(0) = - \left[ \frac{\gamma \hbar g_{\text{eff}}^{1/2} \tau_{mp}^{1/2}}{2\pi M} \cosh(t_{FM}/l_m) - 1 \right] \frac{1}{\sinh(t_{FM}/l_m)} \int d^3k \, n_k^0 \hbar \omega_k^2 \frac{\hbar}{T} \int d^3k \, \tau_k \, v_{k,y}^2 \frac{x e^x}{(e^x - 1)^2} \] \( \nabla T \), \quad (2.40)

This spin current enters the ML and generates a charge current in the x-direction as a result of the inverse spin Hall effect \( \tilde{j}_c = \theta_{SH}(2e/\hbar) \tilde{J}_S^x \times \hat{\sigma} \), where \( \theta_{SH} \) is the spin Hall angle and \( \hat{\sigma} \) is the spin polarization [31]. Using the more accurate (for big \( k \)) magnon dispersion relation \( \omega_k = \omega_{ZB}(1 - \cos \pi k/2k_m) \), a normalized wave number \( q = k/k_m \) and normalized relaxation rate \( \eta_q = \tau_0/\tau_k \), where \( \tau_0 \) is the relaxation time of \( k \approx 0 \) magnons, and integrating the charge current density one obtains the voltage at the ends of the metal layer

\[ V_{\text{LSSE}} = R_N w \lambda_N \frac{2e}{\hbar} \theta_{SH} \tanh \left( \frac{t_N}{2\lambda_N} \right) \frac{B_1 B_s}{(B_0 B_2)^{1/2}} F \rho g_{\text{eff}}^{1/2} \nabla T, \quad (2.41) \]

where \( R_N, t_N, w \) are the resistance, thickness, and width of the metal film, and \( \lambda_N \) is the spin diffusion length in the metal film. Material parameter \( F \), and \( B \) integrals are given by

\[ F = \frac{\gamma \hbar k B \tau_{mp}^{1/2} \tau_0^{1/2} k_m^2 \omega_{ZB}}{8\sqrt{3} \pi^2 M}, \]

\[ B_s = \int_0^1 dq \, q^2 \sin^2 \left( \frac{\pi q}{2} \right) \frac{xe^x}{\eta_q(e^x - 1)^2}, \quad B_1 = \int_0^1 dq \, q^2 \frac{x^2}{e^x - 1}, \quad (2.42) \]

\[ B_2 = \int_0^1 dq \, q^2 \sin^2 \left( \frac{\pi q}{2} \right) \frac{x}{\eta_q(e^x - 1)}, \quad B_0 = \int_0^1 dq \, q^2 \frac{x}{e^x - 1}. \]
Chapter 3. Experimental Methods

This chapter will focus on multiple experimental techniques, procedures, and equipment utilized in preparation and characterization of samples and employed to set up and carry out various low-temperature measurements. X-ray diffraction characterization techniques will be covered first, followed by a summary of sample preparation techniques. Then we will cover the use of dc magnetron sputtering in deposition of thin films on surfaces of bulk samples, do an overview of experimental setups employed in various transport measurements, and finish by outlining the data collection procedures.

3.1 X-ray Diffraction (XRD)

3.1.1 Theory of Operation

X-rays are electromagnetic radiation of wavelength ranging between 0.1 and 100 Å. The most common way to produce X-rays in a lab environment is to use an X-ray tube – a vacuum tube with a voltage between the cathode and the anode high enough to accelerate the elections and make them collide with the anode (typically made of tungsten, molybdenum or copper). If the tube voltage is above the critical value, in addition to continuous bremsstrahlung radiation, sharp high intensity peaks, called characteristic lines,
appear in the spectrum. These characteristic lines are the result of $K, L, M$, etc. spectral line emissions of the anode material. The $K$ series lines $Ka_1, Ka_2, Kβ_1$ (see Figure 3.1 for copper) have the highest intensity and are most suitable for structural studies [32], since their wavelengths are compatible to typical lattice parameters of crystalline solids. Once the characteristic X-rays are produced, the beam undergoes a series of optical treatments e.g. Söller collimators and the useful wavelengths are filtered out by material filters (Fe, Ni, etc.) that are picked to absorb bremsstrahlung and other characteristic lines. After that the beam is incident at the surface of the material to be studied, where it gets partially absorbed and scattered. Waves scattered elastically from crystalline solids produce diffraction patterns described by Bragg’s Law. Figure 3.2 shows a pair of coherent X-rays scattering off two lattice planes separated by distance $d_{hkl}$. The ray reflecting off the bottom plane travels a longer distance to the detector, thus arriving with a different phase $Δφ = 2d_{hkl} \sin \theta$.

If the phase difference is an integer multiple of the wavelength of radiation, the two rays will interfere constructively, creating an intensity peak. Therefore, by rotating the detector and finding the peaks one can extract the distance between various $(hkl)$ planes of the material. In the cubic case,
\[ 2d_{hkl} \sin \theta = n\lambda \] (3.1)

where \( d_{hkl} \) – distance between \( (hkl) \) planes, \( \theta \) – angle of scattering, \( \lambda \) – wavelength of radiation, \( n \) – an integer, representing the order of the diffraction. When the lattice parameters and symmetry group of the material are known, formula (3.1) or crystallographic simulation software allow for easy identification of Bragg peaks determined experimentally.

### 3.1.2 Equipment

All X-ray diffraction studies presented in this work were performed on Phillips X’pert Diffractometer. The diffractometer is equipped with a copper \( (\lambda_{\text{K} \alpha_1} = 1.54056 \text{Å}) \) X-ray tube operating in line and point configurations, incident ray optics, \( \theta - 2\theta \) goniometer with a sample stage, reflected ray optics, and a Xenon proportional counter detector. A detailed drawing of the goniometer is shown in Figure 3.4.

![Figure 3.3. Schematic of the \( \theta - 2\theta \) goniometer with Euler angles labeled.](image)

In addition to the \( 2\theta \) angle traversed by the detector, the sample stage rotates through angles \( \omega, \phi, \text{ and } \psi \), thus completing the set of Eulerian angles. Here, \( \omega \) is the tilt of the sample around the y-axis (the axis perpendicular to the beam in the plane of the sample), \( \phi \) is the rotation of the sample around the z-axis (axis normal to the plane of the
sample), $\psi$ is the tilt of the sample around the x-axis (the axis parallel to the beam in the plane of the sample).

3.1.3 Crystal Orientation

Precise orientation of single-crystalline samples plays a crucial role in measurements focused on anisotropic transport. In addition, transport measurements of magnetic materials are very sensitive to exact alignment of external magnetic field with a particular crystallographic direction of the sample. X-ray diffraction allows for a precise method of sample orientation in virtually any crystallographic direction. If the desired direction is in the plane of the sample, the orientation is carried out by finding the three goniometer angles corresponding to the Bragg peak of the direction that “covers” the sought after in-plane direction and projecting that out-of-plane direction onto the plane. If the desired direction is out-of-plane of the sample, the sample needs to be polished or cut to create a flat surface that is parallel to the desired direction.

3.1.4 Characterization Techniques

In experimental science, consistency and reproducibility are among the top concerns, so it is crucial that every sample measured is properly characterized to account for variations between samples. X-ray diffraction offers a variety of characterization techniques that reveal information about the crystalline quality of the sample, non-stoichiometry, internal strains, twinning, and defects, crystallographic phases, thickness, grain size, and texture in the case of thin films.
Determination of Lattice Parameters.

As was discussed in the previous chapter, Bragg’s Law can be used to obtain distances between lattice plains \((hkl)\). Combined with information about the geometry of the crystal system [32], this can be used to calculate lattice parameters of the solid. Experimentally, one needs to find \(2\theta\) angles of a series of Bragg peaks reflected off an \((hkl)\) plane. In general, the calculation is challenging, since the order of the reflection is \textit{a priori} not known, but the result can be achieved with structure refinement procedures. Most of the times when working with crystals, lattice parameters of the material are already known, but may vary between specimens. These variations can influence physical properties like transport measurements, thus, we employ an advanced procedure based on high angle extrapolation to minimize experimental error in lattice parameter determination. In the case of cubic crystals, the extrapolation function for the interplanar distance \(d_{hkl}(\theta)\) has the following dependence on the scattering angle \(\theta\):

\[
d_{hkl}(\theta) = a_0 + a_0 K \left( \frac{\cos^2(\theta)}{\sin(\theta)} + \frac{\cos^2(\theta)}{\theta} \right)
\]

(3.2)

where \(a_0\) is the true value of the lattice parameter and \(K\) is a constant [32].

Crystalline Quality.

Transport measurements in single crystalline samples are very sensitive to presence of various crystalline defects like point defects, small angle domain walls, twinning, etc. Therefore, a thorough verification of best crystalline quality is required. Pole figure scans allow to identify the presence of low angle domain walls and unwanted domains in the bulk of the crystal. To construct a pole figure, \(2\theta\) is set to a value corresponding to that of a high intensity Bragg peak, and then the sample is rotated through angles \(\phi\) and \(\psi\). The resulting pole figure should match the symmetry of the lattice, and extra peaks at unexpected angles
signal the presence of other domains. Another XRD technique that reveals a lot of information about lattice defects like dislocations, misorientations, and inhomogeneity is the rocking curve scan, which measures the width of the Bragg peak in the \( \omega \) plane. The rocking curve scan is performed by holding the \( 2\theta \) fixed and scanning the \( \omega \) angle through the Bragg peak.

**X-ray Reflectivity (XRR)**

In X-ray reflectivity an X-ray beam is incident on the surface of a thin film at a very small angle (grazing incidence). Incident beam creates specular reflections that are measured by the detector. The resulting oscillatory pattern contains a lot of information about the characteristics of the film like its thickness, critical angle, roughness, density, grain size, etc. Figure 3.7(a) shows a typical XRR pattern. Film thickness \( t \) can be roughly estimated as

\[
t = \frac{\lambda}{2\Delta\theta}\quad (3.3)
\]

where \( \Delta\theta \) is the width of the fringe in radians, \( \lambda \) – the wavelength of X-rays.

A more precise method is to use linear regression based on

\[
q^2 = \frac{2\pi}{t} (m + \Delta m)^2\quad (3.4)
\]

where \( q \) and \( m \) are, respectively, the wavevector the order of maxima or minima of the oscillatory pattern, and \( \Delta m = 0.5 \), if the density of the film is smaller than the density of the substrate (Figure 3.4(b)). Figure 3.4(c) shows the plot of Pt film thickness as a function of deposition times used to calibrate deposition rate of 0.593 \( nm/s \) at a fixed target current \( I_{tar} = 41 \, mA \) and argon pressure \( p_{Ar} = 0.08 \, mbar \).
3.2 Sample Preparation

Steady state thermal conductivity and longitudinal spin Seebeck measurements produce best results, when the measured sample has a regular parallelepipedal shape with faces oriented in specific crystallographic directions. Single crystals oriented by XRD undergo a series of cutting, polishing, and orientation verification steps before a desired geometry is obtained. Materials with high thermal conductivity require the dimension of the sample parallel to the heat flow to be big enough to result in precise measurements of the temperature gradient and the magnitude of spin Seebeck voltage depends on the width perpendicular to external magnetic field, so one of the challenges of sample preparation is to evaluate the shape and orientation of the crystal and make a cut that would maximize those dimensions. Cuts are made with a wire saw shown in Figure 3.5a and the orientation of the cut plane is reconfirmed by XRD. In situations when the cut is a few degrees off from the desired orientation, the cut surface is polished with abrasive grinding papers on a lapping machine (Figure 3.5b) at an angle to eliminate the misalignment. The procedure outlined above is repeated multiple times until the sample is shaped into a parallelepiped.

Figure 3.4. (a) XRR pattern of a 9nm Pt film on Si substrate. (b) Film thickness calculation based on extrapolation formula (Eq. 3.4). (c) Film thickness vs. deposition time.
3.3 Thin Film Preparation

Spin Seebeck measurements rely on the ability of metals with strong spin-orbit coupling (Pt, Ta, W) to convert spin currents to measurable voltages via the inverse spin Hall effect. Typically, the diffusion length of spin currents into the metal is on the order of a few nanometers [33], [34], therefore a thin film of one of listed materials constitutes an excellent spin current detector. In spin Seebeck experiments described in this work, platinum films with thickness 8-10 nm have been deposited by DC magnetron sputtering onto the face of the sample perpendicular to the direction of the heat flow. The outcome of a spin Seebeck experiment strongly depends on the quality of the thin film and treatment of the surface it’s deposited on [35], [36], so the following sections will outline the procedure used to prepare the surface before the deposition and methods employed to characterize the deposited film.

3.3.1 Surface Treatment

Each sample described in this study underwent the three step surface preparation process. First, the narrow rectangular face of the sample was polished with abrasive grinding papers of decreasing roughness on a lapping machine: 1) Silicon Carbide, 25μm;
2) Silicon Carbide, 5μm; 3) Silicon Carbide, 1μm; 4) Aluminium Oxide, 0.3μm. Due to the small dimensions of the sample, it was attached to a copper block with crystalbond, so that the polished surface is flush with the copper to minimize the stress on the sample during polishing. After that the entire sample was cleaned in an ultrasonic bath and mounted on a custom sample holder with crystal bond. Then the surface was treated with the Piranha solution (3:1 mixture of concentrated sulfuric acid and 30% hydrogen peroxide) by dipping the polished end of the sample in a Petri dish with solution to remove remaining organic residue. Over the span of multiple experiments described in this study, treatment times have been reduced from 60s to 5s as a result of an observation of a strong etching of the sample surface. After the Piranha treatment the sample was rinsed with deionized water and dried with air, followed by an immediate transfer to the deposition chamber.

### 3.3.2 Magnetron Sputtering

![Schematic of the sputtering chamber](image)

Figure 3.6. (a) Schematic of the sputtering chamber. (b) Sample holder and shadow mask.

Magnetron sputtering is a physical vapor deposition process primarily used in fabrication of thin films. In the process, the sputtering gas is ionized, and positively charged ions are accelerated by the electric field towards the cathode, bombarding and ejecting
atoms from the target. Ejected atoms then diffuse away from the target and condense on the sample (see Figure 3.6a).

A Cressington 108 sputter coater with platinum target installed was used to deposit films on all Cu$_2$OSeO$_3$ samples in this study. Ultra high purity argon was used as the sputtering gas and the vacuum chamber was pumped with a diffusion pump. Deposition rates were calibrated by performing reflectivity thickness measurements (see Section 3.1.4) on a series of Pt/Si samples with increasing deposition times. All other deposition parameters like the distance from the target, argon pressure, and target current were not varied.

The thin film deposition procedure consisted of the following steps. Once the etched and dried sample was transferred into the deposition chamber, a shadow mask was installed on top of the sample holder cap. The shadow mask cut from microscope slide cover was designed to expose the narrow polished face of the sample while keeping the rest of the sample masked. In addition, the shadow mask was aligned flush with the face of the sample to guarantee complete and uniform coverage (Figure 3.6b). After that the vacuum chamber was sealed and pumped with a diffusion pump to the base pressure of 1 \times 10^{-5} \text{ mbar} and flushed with argon three times. The argon pressure in the chamber was set to $P_{Ar} = 1 \times 10^{-2} \text{ mbar}$ and the platinum was deposited for 80 seconds at the target current of 16mA.

Four thin (0.001" diam.) gold are attached at the two ends of the platinum film with silver epoxy (Epo-Tek® EE165) and the sample is annealed in a 250°C furnace for 15 mins to cure the epoxy and improve contact resistance.
3.3.2 Film Characterization

Thin films are characterized with XRR to determine their thickness, roughness, and grain size. Other characterization techniques involve low-temperature measurements of resistivity, magnetoresistance, and Hall coefficient (see Section 6.2).

3.4 Transport Measurements

Our lab specializes on low temperature transport measurements and a number of different measurements were performed in the scope of this work. This section will discuss the equipment, experimental techniques, and setups used for the measurements.

3.4.1 Thermometers and Thermocouples

Ruthenium Oxide Thermometers

Ruthenium oxide bare chip thermometers are excellent temperature sensors for temperatures below 20K. Their characteristic feature is that the resistance of the amorphous ruthenium oxide film increases very fast with decreasing temperature, so a small change in the temperature of the film results in a big change in its resistance, allowing for a very precise measurement of absolute temperature. The resistance of the film is measured using the 4-wire configuration, and then converted to absolute temperature using T(R) calibration curves shown in Figure 3.7. Bare chip sensors come uncalibrated, so they need to be calibrated against a standard precalibrated thermometer in a separate experiment to obtain T(R) data.
Figure 3.7. Typical $T(R)$ calibration data of a bare-chip Ruthenium oxide thermometer (circles). Fits based on Eq. 3.5 (lines).

The data are fit with the piece-wise model and non-linear regression is used to determine fit coefficients.

$$
T(R) = \begin{cases} 
A_1 \left( \frac{B_1}{(T + C_1)^{D_1}} \right), & \text{when } 0K < T \leq 1K \\
A_2 \left( \frac{B_2}{(T + C_2)^{D_2}} \right), & \text{when } 1K < T \leq 3.5K \\
A_2 + B_2 T^2 \ln(T), & \text{when } 3.5K \leq T 
\end{cases} \tag{3.5}
$$

Thermocouples

A thermocouple is a temperature sensor that consists of two wires made of metals with very different Seebeck coefficients ($S_1$ and $S_2$), that are welded together at one end to form a junction. Whenever there is a temperature gradient $\Delta T$ between the junction and the ends of the thermocouple, the difference in the Seebeck coefficients $S_1 - S_2$ of the two metals produces a voltage $V$ across the two ends. If the absolute temperature of the ends $T_{ref}$ is known, the temperature of the junction $T_{junction}$ can be calculated using the formula

$$
T_{junction} = T_{ref} + \frac{V}{S_1 - S_2}. \tag{3.6}
$$

Type E (chromel-constantan) thermocouples are very useful in low temperature measurements, because of their high voltage output at cryogenic temperatures.
3.4.2 Resistivity and Magnetoresistance

The DC resistance measurement that utilizes the 4-wire setup is the most commonly used method often employed to measure resistivities of bulk single crystals, thin films, or resistances of various resistive devices like thermometers and heaters. This method has a number of advantages over the 2-wire setup: current reversal accounts for various offsets, resistances of the leads and contact resistances are ignored. Leads A are designed to create a uniform current density throughout the specimen. The current $I$ is supplied by a Keithley 220 programmable current source that can output currents in the range between 100nA and 1A. Leads B are used to measure the voltage drop $V$ using a Keithley 2182A, able to detect voltages between 3V and 10nV. These instruments then can be used to measure resistances in the range from 10nΩ to 30kΩ. The resistivity of the sample can be calculated using

$$\rho = \frac{V A}{I l}$$

(3.7)

where $V$ is the voltage across leads B, $I$ is the current through leads A, $A$ is the cross-sectional area of the specimen, and $l$ is the distance between leads B. The biggest challenge of this method is to ensure that the current density between leads A is uniform, that is why it is particularly important to create contacts of the right shape. The contacts can be hand painted on with a conductive silver epoxy, or magnetron sputtering can be used to deposit Au or Pt contacts through a shadow mask (see Section 3.3.2). In this work the technique was used multiple times in the following situations: resistance of ruthenium oxide thermometers was measured and converted to absolute temperature, resistance of chip heaters was used to calculate the power output of the heater, resistance of the platinum film
was measured as a function of temperature and magnetic field to investigate the effects of proximity magnetization on spin Seebeck effect (more in Section 6.2).

3.4.3 Thermal Conductivity

There is a number of experimental techniques that can be used to measure thermal conductivity $\kappa$, but the most advantageous method for measuring thermal conductivity of single crystals with heat flow in a particular crystallographic direction is the steady state method. The schematic of the measurement setup is shown in Figure 3.8.

![Figure 3.8. Schematic of the thermal conductivity measurement setup.](image)

To achieve the desired configuration, the first step is to cut a rod-like specimen with dimensions $l \times w \times t$ out of an oriented single crystal, so that the length of the rod is parallel to the desired crystallographic direction, and the crosssection is rectangular and uniform (to guarantee a uniform temperature gradient required for this method). Then the sample is attached to a thermally conducting heat sink (typically OFHC copper) with an epoxy appropriate for the measurement. The common thermally conducting epoxies are silver paint, GE varnish, stycast, E20 silver epoxy, etc, and a number of factors need to be considered when choosing the right one, including the temperature range of the
measurement, electrical conductivity, ability to adhere to the surface of the crystal, grain size/uniformity, and mechanical strength. The third step is to attach the resistive chip heater (look up the manufacturer) to the cantilever end of the sample, thus creating a heat flow $\mathbf{j}_d$ through the sample from the heater to the sink. There are a few options regarding what temperature measuring devices to use to measure the temperature gradient and the average temperature of the sample, depending on the desired temperature range. At low temperatures, $0.1K \leq T \leq 20K$, Ruthenium Oxide chip thermometers provide the best temperature resolution, in addition, their low magnetoresistance makes them really useful for field dependent measurements. For all other temperature ranges, a combination of a differential thermocouple and an average thermocouple of type E or K can be used. The junctions of the differential thermocouple (or RuO$_2$ thermometers via thick gold wires) are attached to the sample at a maximum separation, while the average thermocouple junction is placed in between the two. In the steady state method, thermal conductivity is calculated by

$$\kappa(T_{avg}) = \frac{V_{htr} I_{htr} l_{dT} l_{avg} A}{\Delta T}$$  \hspace{1cm} (3.8)

where $V_{htr}$ is the heater voltage, $I_{htr}$ is the heater current, $\Delta T$ is the temperature difference between the points separated by length $l_{dT}$, and $A = wt$ is the cross-sectional area of the sample. The current through the heater $I_{htr}$ is supplied by the Keithley 220 programmable current source, the voltage $V_{htr}$ is measured with the Keithley 2182A nanovoltmeter in a four wire setup. In the case of resistive thermometers, the four wire method is used to calculate the resistance of each thermometer, which is later converted to the absolute temperature using $T(R)$ calibration curves (see 3.4.1). The temperature difference $\Delta T$ and the average temperature $T_{avg}$ are then calculated by finding the difference and the average
of two thermometer readings, respectively. In the case of thermocouples, the two voltages $V_{diff}$ and $V_{lag}$ of the differential and the average thermocouples, respectively, are measured by a nanovoltmeter and then converted to the temperature difference and average temperature by the method described in 3.4.1). In some situations it is possible to have a non-zero temperature gradient along the sample even when the heater is off. In order to account for that in the calculation of thermal conductivity, a separate measurement of zero heater power (heater off) temperature gradients needs to be performed throughout the temperature range, giving a function $\Delta T_{ohtr}(T_{avg})$. Then the true thermal conductivity can be calculated by

$$
\kappa(T_{avg}) = \frac{V_{htr} I_{htr}}{\Delta T - \Delta T_{ohtr}(T_{avg})} \frac{l_{\Delta T}}{A}.
$$

(3.9)

### 3.4.4 Spin Seebeck Effect

![Schematic of the spin Seebeck effect measurement setup.](image)
Spin Seebeck effect in Cu$_2$OSeO$_3$ was measured in the longitudinal configuration presented in Figure 3.9. This setup is similar to the one for thermal conductivity measurements presented in Section 3.4.3 except for the addition of an 8-10 nm platinum (Pt) thin film on the face perpendicular to the heat flow direction. In order to maximize the LSSE signal, several considerations regarding sample geometry need to be taken into account.

First, samples need to be of parallelepipedal geometry that maximizes the length $l$ along the heat flow to produce the maximum temperature difference $\Delta T_x$, as LSSE voltage is directly proportional to the temperature gradient. Secondly, since LSSE voltage originates as an electric field of inverse spin Hall effect integrated along the width $w$ of the sample, the width needs to be maximized as well. The second condition competes with the first, since the geometric factor $g = \frac{l}{wt}$ ultimately determines the magnitude of the temperature difference. Experimentally, it is beneficial to have the biggest possible geometric factors for materials with high thermal conductivity to avoid temperature differences at the limit of thermometer sensitivity. For majority of the samples, the length is determined by the size of the bulk single crystal it is cut from, thus reducing thickness $t$ of the sample while keeping $w$ relatively large is the strategy that maximizes the LLSE signal. With the heat current $j_q$ in the $\hat{x}$ direction and magnetic field $\vec{H}$ in the $\hat{y}$ direction, the inverse spin Hall voltage in the platinum strip is expected to be in the $\hat{z}$ direction, thus four 0.001-inch diam. wires are attached at the two ends of the strip.
Figure 3.10 (from Ref. [38]). (a) Schematic illustration of the Pt/YIG/Pt sample. (b) Experimental configuration for applying $\nabla T$. (c) A schematic plot of temperature profile along the $z$ direction.

The setup described is distinguished from the measurement configurations typically used in the studies of LSSE in bulk YIG (Figure 3.10a) but offers certain advantages. Since thermal conductivity of YIG is much smaller, wide, short samples are sandwiched between two heat baths with sapphire plates on the two sides to produce uniform heat flow. The temperature of the two sapphire plates is directly measured and the difference is taken to be equal to the temperature difference in the YIG slab. Figure 3.10c shows that this approach is prone to erroneous measurements of the temperature gradient as the actual temperature profile across the stack is rather complicated due to a finite thermal resistance of the contacts between the YIG and sapphire plates. Instead, authors of Ref. [37], [38] propose to use platinum films deposited on the two ends as thermometers by calibrating the temperature dependence of their resistance.

This method improves the accuracy of the temperature gradient measurement at $T > 20K$ but gives poor results at low temperatures as platinum resistance becomes weakly
temperature dependent in the residual resistance regime. Also, this method complicates the analysis of magnetic field dependence as separate calibrations over the entire temperature range need to be performed to determine the film resistance as a function of field and temperature. Therefore, the method described in this section has definite advantages as it affords directly measured temperature gradients with sensitive, calibrated (in field) thermometers.

3.5 Data Acquisition

3.5.1 Equipment

A wide range of equipment was used to enable fast and reliable measurements and recording of the data in the experiments described in this work. A fully automated setup of Keithley® 224 programmable current sources, model 182 and 2182 nanovoltmeters, a model 705 switch system, Lakeshore® 335 temperature controllers, and a model 625 superconducting magnet power supply, communicating via GPIB interface was used for to perform measurements and transfer the results to a PC.

All low-temperature measurements were performed in the Cryo Industries of America, Inc model He3-PRO® dipper probe equipped with a 5T superconducting magnet placed in a dewar with liquid helium. The probe’s cooling system is capable of maintaining a base temperature of 300 mK for extended periods of time. The key components of the cooling system – charcoal chamber, condensation pot (He⁴ pot), and He³ pot – are shown in Figure 3.11.
Figure 3.11 (adapted from [39]). Components of He³ probe cooling system and steps of operation.

The principle of operation is based on thermodynamic cycling of He³ gas that occurs in the following steps:

1) The charcoal chamber is heated and the stored He³ gas is released
2) He³ gas passes through the condensation pot at temperatures below 1.7K and condenses in the He³ pot, then charcoal heater is switched off and liquid He³ provides cooling power for the sample stage
3) Heat loads on the sample stage evaporate liquid He³ that is physisorbed on the charcoal surfaces.

Sample vacuum space is diffusion pumped and backed by an Edwards® Model 1.5 dual stage rotary pump. Pumping on the charcoal chamber and He4 pot is done with an Edwards® Model 5 dual stage rotary pump.
3.5.2 Software

The data acquisition was performed using an automated LabView routine designed to communicate with digital equipment, coordinate a measurement sequence, and record data. Additional features were used to monitor temperature changes of stage thermometers and condenser pot thermometers to guarantee excellent temperature stability over the course of multiple-hour magnetic field sweeps at fixed temperature setpoints.
Chapter 4. Cu$_2$OSeO$_3$ – Overview of Properties

In this chapter we will go over the physical properties of Cu$_2$OSeO$_3$ and review relevant experimental and theoretical work published about this material. We will also develop an understanding of the key properties of Cu$_2$OSeO$_3$ that motivated the study of thermal conductivity and spin Seebeck effect in this material. In addition, we will draw comparisons with YIG and discuss the avenues the study of Cu$_2$OSeO$_3$ can lead to, establishing the potential contributions to the field of spin caloritonics it can bring.

4.1 Structure

The first studies of CuO-SeO$_2$ compounds were done by G. Meunier and M. Bertaud in 1976 [40]. X-ray analysis of single crystals and powder samples was used to determine the cubic lattice system and the space group P2$_1$3 of Cu$_2$OSeO$_3$. A 1986 study by H. Effenberger and F. Pertlik determined the crystal structure, atomic positions, and the lengths of Cu-O and Se-O bonds [41]. Bos et. al. [42] grew single crystals of Cu$_2$OSeO$_3$ by the chemical vapor transport (CVT) method, refined the crystal structure via XRD and neutron powder diffraction, and measured thermal expansion, magnetization, ac susceptibility, and dielectric constant over a wide temperature range with the focus around the Curie temperature $T_c \approx 58K$. Further analysis of the structure revealed that, the noncentrosymmetric P2$_1$3 space group implies Cu ions form a distorted, three-dimensional pyrochlore lattice of corner sharing tetrahedra (Figure 4.1a). Within the tetrahedra there are two inequivalent sites of Cu$^{2+}$ with different oxygen coordination (Cu$_1$ and Cu$_2$). Cu$_1$ ions are surrounded by square pyramids of oxygen ligands, while Cu$_1$ ions are surrounded by trigonal bipyramids. Magnetization was found to saturate at a value of 0.5$\mu_B$/Cu$^{2+}$ which
supported the collinear ferrimagnetic alignment of copper spins within the tetrahedra with three (Cu$_2$) pointing in the same direction and one (Cu$_1$) antiparallel (Figure 4.1b). The absence of spontaneous lattice strain, magnetostructural coupling, as well as anomalous behavior of dielectric constant and magnetocapacitance suggested a unique nature of magnetolectric coupling.

Figure 4.1 (from Ref. [48]). (a) Crystal structure of Cu$_2$OSeO$_3$. Cu$_1$ in blue, Cu$_2$ in green, O in red, Se in grey. (b) Orientation of Cu$^{2+}$ spins.

Belesi et al. reported a nuclear magnetic resonance (NMR) study of $^{77}$Se nuclear spins in Cu$_2$OSeO$_3$ [43]. The NMR effectively probes the electronic moments of Cu$^{2+}$ atoms through the transferred hyperfine and magnetic dipolar interactions with $^{77}$Se nuclear spins. The study confirmed the ferrimagnetic ordering of Cu$^{2+}$ spins within the tetrahedra and identified anomalous behavior around $T_c$ of spectral lines associated with phonon modes responsible for the magnetolectric effect.

4.2 Magnetism

Metallic B20 alloys share the noncentrosymmetric space group P2$_1$3 with Cu$_2$OSeO$_3$ and exhibit chiral helimagnetic order. These B20 compounds were also shown to host topological spin vortices – skyrmions. Structural similarities of Cu$_2$OSeO$_3$ with transition metal alloys with B20 structure, like MnSi [44], [45], Fe$_{1-x}$Co$_x$Si [46], and FeGe
[47] motivated a series of small angle neutron scattering (SANS) and Lorentz TEM imaging studies of its magnetic structure. The studies [48], [49],[51] revealed that below the transition temperature, competing $\vec{S}_i \cdot \vec{S}_j$-like ferromagnetic exchange and $\vec{S}_i \times \vec{S}_j$-like Dzyaloshinskii-Moriya (DM) interactions (favoring parallel and perpendicular spin alignment, respectively) result in helimagnetic ordering of S=1 tetrahedra below $T_c$ and are also responsible for the appearance of the skyrmion phase near $T_c$.

Figure 4.2. (a-c) (from [52]) Spin textures in the helimagnetic, conical, and skyrmion phases, respectively. (d) (from Ref. [51]) Magnetic phase diagram.

Figure 4.2a shows an illustration of the spin configuration in the helical phase; here the total spins of the tetrahedra rotate in the plane perpendicular to the propagation vector $k = 2\pi/\lambda_h$, that is parallel to the $<100>$ crystallographic directions and $\lambda_h \approx 616 \pm 45$ Å is the modulation wavelength. This particular direction of the propagation vector is caused by the magnetic anisotropy, while the high symmetry of the cubic lattice results in three coexisting $<100>$ domains as confirmed by SANS. As the external magnetic field increases, Cu$_2$OSeO$_3$ undergoes a second order phase transition at the first critical field $H_{c1}$ from the helical into the conical phase, where the spins begin to rotate on the surface of a cone and the propagation vectors align with the direction of the field forming a single domain (Figure 4.2b). Above the second critical field $H_{c2}$ the spins of the tetrahedra align
parallel with the magnetic field and the material is in the field-polarized (or collinear) phase, while maintaining the ferrimagnetic ordering within the tetrahedra at least up to 14T [43]. The phase diagram for the magnetic phases described so far is presented in Figure 4.2d.

Recently, Qian et al. [53], Chacon et al. [54], and Halder et al. [55] experimentally observed two new spin phases of Cu$_2$OSeO$_3$: a low-temperature skyrmion phase and a so-called tilted conical phase. Both new phases occur exclusively when the magnetic field direction is along the [100] crystallographic direction, favored by cubic anisotropy. The tilted conical phase (TC) is characterized by a tilt of the direction of conical modulation away from the field direction toward <111> directions, resulting in a multidomain phase with temperature dependent tilt angle. The phase occurs at magnetic fields near $0.6\cdot H_{c2}$ and is stabilized by competing magnetic anisotropies.

![Figure 4.3](from Ref. [54]). (a) Magnetic phase diagram observed for ZFC/FH and field parallel to $\langle 111 \rangle$. (b-d) Magnetic phase diagrams observed for ZFC/FH, FC, and HFC/FH, respectively, for field parallel to $\langle 100 \rangle$. Hatched shading represents coexistence of skyrmion and TC phases.

Chacon et al. argued that the observed ring of scattering intensity that is perpendicular to the field in parts of the tilted conical phase can be attributed to the presence of a triangular skyrmion lattice (LTS). Additionally, they concluded that the transition from the conical phase to the TC is second order, while the transition from FP to TC is first
order. All transitions to LTS are strongly first order and are additionally protected by topology. Figure 4.3 shows the magnetic phase diagram obtained from SANS data for three temperature vs field protocols: zero-field-cooled/field-heated (ZFC/FH), field-cooled (FC) and high-field-cooled/field-heated (HFC/FH).

### 4.3 Heat Capacity

Recently, magnetic field dependence of specific heat of Cu$_2$OseO$_3$ had been reported by Halder et al. [55]. These data turn out to be very useful in the analysis of magnetic dependence of thermal conductivity presented in Section 5.3. Figure 4.4 shows the change in specific heat $\Delta C = C(B) - C(H = 0)$ at $T = 2$ K as a function of magnetic field for three principal crystallographic directions.

![Figure 4.4](from Ref. [55]). Field dependence of specific heat at 2 K for three principal directions. Red (blue) circles correspond to increasing (decreasing) field.

### 4.4 Crystal Growth

The bulk single crystal specimens used in this study were prepared by our collaborators (group of Tyrel McQueen at Johns Hopkins University) using the seeded chemical vapor transport method described in [58].
First, polycrystalline Cu$_2$OSeO$_3$ is synthesized by a direct solid-state reaction of CuO and SeO$_2$. Ground up precursors (in a 2:1 molar ratio) are sealed in an evacuated fused silica ampule and the temperature is ramped to 600°C at a rate of 100°C/hr. and held at 600°C for 12 hours, followed by a quench of the tube in water. To grow single crystals Cu$_2$OSeO$_3$ powder is sealed in a fused silica ampule with 0.4 mg/cm$^3$ NH$_4$Cl. The tube is then positioned between the first two zones of a three-zone tube furnace. The source zone is ramped to 640°C and the deposition zone – to 530°C as depicted in Figures 4.5 a, b and the temperature gradient is maintained for 6 weeks. The obtained small single crystal specimens are then used in the seeded CVT growth, producing large, olive green Cu$_2$OSeO$_3$ crystals shown in Figure 4.5c. Powder XRD was used to confirm phase purity and back-reflection X-ray Laue diffraction was utilized to identify crystal faces and verify crystalline quality.
Chapter 5. Thermal Conductivity of Cu$_2$OSeO$_3$

We will start this chapter by going over the considerations that drew our attention to Cu$_2$OSeO$_3$ and motivated our study of its thermal conductivity. Then the essential results of thermal conductivity studies, published by our group [59], [60], will be presented.

5.1 Skyrmion Thermal Hall Effect

Originally Cu$_2$OSeO$_3$ drew our attention because of the possibility of an observation of skyrmion thermal Hall effect. Recent theoretical work [61], [62] described skyrmion dynamics in the presence of a temperature gradient. These studies found that in addition to the usual Brownian drift of skyrmions opposite to the temperature gradient, there is an overwhelming flow in the opposite direction caused by negative spin transfer torques on skyrmions caused by the magnon current induced by the temperature gradient. The overall drift is in the direction along the temperature gradient (cold to hot), contrary to the intuitive diffusion direction of other carriers and quasiparticles. In addition, the theory suggests that the DM interaction in the presence of an external magnetic field results in skyrmion drift transverse to the temperature gradient. The heat current produced by this motion of skyrmions creates a transverse temperature gradient.

The first experiments done by our group focused on measuring the proposed skyrmion thermal Hall temperature gradient. The measurement setup, displayed in Figure 5.1, was similar to the thermal conductivity setup described in Chapter 3 with type E differential thermocouples measuring the longitudinal and transverse temperature differences.
The sample with length $l$ parallel to the [111] crystallographic direction and width $w$ perpendicular to [110] was cooled to ~58K and a number of field sweeps in and outside of the skyrmion phase were performed. In addition, DC magnetization measurements were performed in a PPMS system with ACMS II by our collaborators (group of Sunxiang Huang at the University of Miami). Figure 5.2 shows $dM/dH$ and $\kappa_{xy} = \kappa_{yy} \frac{\nu_y T}{\nu_x T}$ as functions of magnetic field. Evidently, the skyrmion thermal Hall signal is below the level of detection, which is determined by the sensitivity of the thermocouple.

Even though measurement of the skyrmion thermal Hall yielded a null result, thermal conductivity in zero field showed a surprisingly high magnitude at low temperatures, which motivated further investigation.
Figure 5.2. \( \frac{dM}{dH} \) and \( \kappa_{xy} \) as functions of magnetic field in the skyrmion phase (red) and above \( T_c \) (blue). Shading indicates the skyrmion phase (SkL).

5.2 Thermal conductivity with heat flow along [111]

5.2.1 Overview

This study presents the results of thermal conductivity measurements of Cu$_2$OSeO$_3$ samples with heat flow \( \vec{j}_q || [111] \) and external magnetic field \( \vec{H} || [1\bar{1}0] \). Single crystal samples were cut from different bulk single crystal specimens and the orientation and crystalline quality were verified by X-ray diffraction. The experimental setup used for thermal conductivity measurements is described in Section 3.4.3. Temperature-dependent thermal conductivity in \( H = 0 \) kOe and \( H = 50 \) kOe as well as magnetic-field-dependent thermal conductivity measurements were performed. Analysis of the data reveals that thermal conductivity can be separated into additive contributions from phonons and magnons. The extracted magnon thermal conductivity with the magnitude of \( \sim 70 \) W/mK at 6K greatly exceeds that measured in any other ferro- or ferrimagnet. Both phonons and
magnons conduct heat in the boundary-limited regime at low temperatures, while Poiseuille flow of magnons in the temperature region $2K < T < 10 K$ was identified.

### 5.2.2 Thermal Conductivity in Zero Magnetic Field

![Graph showing temperature dependence of thermal conductivity for three samples with varying transverse dimensions $l_0$ in $H = 0$ kOe.](image)

Figure 5.3. Temperature dependence of thermal conductivity for three samples with varying transverse dimensions $l_0$ in $H = 0$ kOe.

The zero-field thermal conductivity ($\kappa$) of three samples with differing transverse dimensions ($l_0 = 2\sqrt{a/\pi}$, where $a$ is the cross-sectional area) are shown in Figure 5.3 for the temperature range $0.5 K < T < 20K$ and zero magnetic field is shown in Figure 5.3. At very low $T$, $\kappa$ scales with the transverse dimension $l_0$, indicating that scattering from boundaries is the dominant relaxation mechanism with mean-free paths approaching the value of $l_0$ as $T \to 0 K$ (ballistic regime, see Section 5.2.4). The thermal conductivities have maxima at $\sim 8 K$ and reach $\sim 400 W/mK$ for the largest sample. The magnitude of $\kappa$ at
the peak is usually determined by defect scattering, therefore slight differences between the three samples can be attributed to different defect concentrations. Additionally, at low temperatures $\kappa(T)$ strongly deviates from the $T^3$ behavior expected for lattice thermal conductivity of an insulator. This is due a magnon contribution to $\kappa$ (see Section 5.2.3).

5.2.3 Magnetic Field Dependence of Thermal Conductivity

Magnetic field dependence of thermal conductivity was measured at a series of fixed field values from -50 to 50 kOe while keeping the base temperature fixed. The results of the measurements from 0 to 50 kOe for samples with transverse dimensions $l_0 = 0.15$ mm and 0.31 mm are shown in Figure 5.4.

The first key feature of the data is the saturation of $\kappa$ at low temperatures as magnetic field approaches 50 kOe in the field polarized (collinear) phase. In the presence of external magnetic field at low temperatures, the magnon dispersion relation can be approximated as $\hbar \omega_k = D k^2 + g \mu_B H$. An increasing magnetic field suppresses magnon population (Eq. 2.1). In the case when magnetic field is strong enough $g \mu_B H \gg k_B T$, thermal conduction by magnons is completely suppressed and the total thermal conductivity is determined purely by the lattice contribution. At low temperatures the suppression occurs at $g \mu_B H / k_B T \approx 6$, which explains why the saturation is not observed in the $T = 5.2$ K data (lower panel of Figure 5.4a) – the estimated field strength required to suppress all magnons is approximately 220 kOe. The suppression at 50 kOe occurs for temperatures below 1.2 K.
Figure 5.4. Magnetic field dependence of thermal conductivity, average temperature, and dM/dH for samples with transverse dimensions $l_0 = 0.15\text{mm}$ (a) and $0.31\text{mm}$ (b).

We assume weak phonon-magnon interactions, that imply simple additive contributions to the total thermal conductivity from phonon (L) and magnon (m) systems $\kappa = \kappa_L + \kappa_m$. We take the saturation value to be equal to the lattice thermal conductivity $\kappa_L$ and compute the magnon thermal conductivity in each spin phase ($\kappa_m^{\text{hel}}, \kappa_m^{\text{con}}, \kappa_m^{\text{col}}$ in Figure 5.4a) at low temperatures by direct subtraction.

The second feature is the sharp increase in thermal conductivity at the helical-conical transition. This jump is unlikely to be caused by changes in the magnetic texture, as specific heat does not exhibit similar behavior at the transition (see Figure 4.4), therefore, the effect is caused by the change in magnon scattering. It is reasonable to attribute the observed behavior to the transition from the multidomain state in the helical phase to the single domain conical phase. Evidently, domain boundaries in the helical phase
are very effective at scattering magnons and cause a considerable suppression of thermal conductivity. Interestingly, the increase of thermal conductivity in the conical phase opposes the decrease in specific heat.

### 5.2.4 Magnon Thermal Conductivity

In order to perform the separation of magnon contribution from the total thermal conductivity, lattice thermal conductivity at temperatures where the saturation does not occur at the magnetic field of 50 kOe was computed using the Calloway model (Section 2.1.3). The parameters of the model were constrained to satisfy the following conditions:

1. \( \kappa_L \) fits the low temperature \( (T < 1.2 \text{K}) \) 50 kOe data, where the direct suppression is observed;
2. \( \kappa_L \) fits the high temperature \( (T < 1.2 \text{K}) \) zero-field data, where \( \kappa \) shows negligible field dependence;
3. the maximum in \( \kappa_m^{\text{con}} = \kappa - \kappa_L \) occurs at the same temperature where \( \kappa_m^{\text{con}} - \kappa_m^{\text{hel}} \) peaks;
4. \( \kappa_L < \kappa \).

Normal and resistive scattering rates were taken to have the form

\[
\tau^{-1}_N = \gamma A x^2 T^4. \tag{5.1a}
\]

\[
\tau^{-1}_U = \frac{\nu}{\ell_0} + A x^2 T^4 \exp \left( \frac{\theta D}{B T} \right) + C x^4 T^4, \tag{5.1b}
\]

where \( A, b, C, \) and \( \gamma \) are free parameters. Figure 5.5 shows the obtained fits to the lattice thermal conductivity, while the parameter ranges are summarized in Table 5.1.
Table 5.1. Ranges of parameters from Callaway modeling of $\kappa_L$.

<table>
<thead>
<tr>
<th>$l_0$ (mm)</th>
<th>$v$ (km/s)</th>
<th>$A$ ($10^4$ K$^{-4}$)</th>
<th>$b$</th>
<th>$C$ (K$^{-4}$)</th>
</tr>
</thead>
<tbody>
<tr>
<td>0.15</td>
<td>2.06 – 2.15</td>
<td>1.8 – 2.0</td>
<td>6.6 – 6.9</td>
<td>10 – 15</td>
</tr>
<tr>
<td>0.31</td>
<td>2.15 – 2.35</td>
<td>1.5 – 1.8</td>
<td>6.0 – 6.6</td>
<td>80 – 110</td>
</tr>
<tr>
<td>0.60</td>
<td>2.06 – 2.3</td>
<td>1.75 – 2.0</td>
<td>6.3 – 6.6</td>
<td>34 – 40</td>
</tr>
</tbody>
</table>

Figure 5.5. Zero field thermal conductivity from Figure 5.3 (circles) and $\kappa_L$ computed for the two ends of the parameter range (solid and dash-dotted curves). Shaded regions correspond to parameter ranges from Table 5.1.

Magnon thermal conductivity in the conical phase was calculated by subtracting $\kappa_L$, computed using the mean values of the ranges from Table 5.1, from the maximum total thermal conductivity in the conical phase. Obtained $\kappa_m^{con}$ reaches a value of $\sim 70$ W/mK at the peak near 5K, which is the record high magnitude for magnon thermal conductivity of ferro- and ferrimagnetic materials. Moreover, for $T > 1$K $\kappa_m^{con}$ of the two least defective samples (blue and green circles in Figure 5.6) grows with temperature at a rate much faster than $T^2$ predicted by linear spin wave theory (Eq. 2.23). This temperature behavior can be explained by two possible mechanisms: 1) magnon-phonon drag, 2) Poiseuille flow of
magnons. The former predicts a much stronger temperature dependence ($\propto T^4$) [63], so we explore the second possibility in Section 5.2.5.

Figure 5.6. Magnon thermal conductivity in the conical phase (circles). Magnon thermal conductivity of YIG (squares) from Ref. [64].

5.2.5 Ballistic Regime of Phonon and Magnon Conduction

Figure 5.7 shows the low-temperature thermal conductivity at $H = 0$ kOe and $H = 50$ kOe. At 50 kOe $\kappa$ is proportional to $T^3$, further corroborating the argument that high-field thermal conductivity is purely due to the lattice at low temperatures (Section 5.2.3). The expression for low temperature, boundary-limited thermal conductivity (Eq. 2.15b) was used to model the $H = 50$ kOe data, yielding phonon mean-free paths $l_{ph} \approx 0.16, 0.24, 0.59$ mm, consistent with the effective transverse dimensions of the samples.

The model for boundary limited magnon thermal conductivity (Eq. 2.23b) was used to fit the low-temperature part of Figure 5.6 data, yielding magnon mean-free paths
\( l_m \approx 0.14, 0.25, 0.28 \text{ mm} \), which agree well with the transverse dimensions except in the case of the largest sample, where a single magnetic domain might not be as big as the crystal.

The above results confirm that both magnons and phonons conduct heat in the boundary-limited (ballistic) regime at low temperatures.

Figure 5.7. Low temperature thermal conductivity of the three samples from Figure 5.3: \( \kappa(H = 0 \text{ kOe}) \) – circles, \( \kappa(H = 50 \text{ kOe}) \) – triangles. Solid lines – fits to Eq. 2.15b.

5.2.6 Poiseuille Flow of Magnons

Microscopically Poiseuille flow is characterized by quasiparticle mean-free paths greatly exceeding the limits imposed by boundary scattering [65], [66]. Many momentum conserving scattering events occur before the particle thermalizes at the boundary, effectively resulting in a random walk with step size \( l_N \). This effect is only possible in a narrow range when \( l_N < l_0/2 < (l_N l_U)^{1/2} \) and the mean-free path approaches \( \frac{l_0^2}{4l_N} \gg l_0 \).

The model for Poiseuille flow was developed by Alvarez and Jou [67]
\[ \kappa_m = \frac{1}{3} C_m v_m [l_0^B (1 - \Sigma) + l_U F(L_{eff}) \Sigma], \] (5.2a)

\[ F(L_{eff}) = \frac{1}{2\pi^2} \left( \frac{L_{eff}}{l} \right)^2 \left[ \sqrt{1 + 4\pi^2 \left( \frac{l}{L_{eff}} \right)^2} - 1 \right], \] (5.2b)

where \( \Sigma = 1/(1 + l_N/l_U)^2 \), \( L_{eff} = \pi l_0 / 2\sqrt{2} \), \( l = \sqrt{l_N l_U} \), \( l_U = (1/l_{3U} + 1/l_{4U} + 1/l_i)^{-1} \), \( l_U^B = (1/l_0 + 1/l_U)^{-1} \), and \( l_{3U}, l_{4U}, 1/l_i \) are the mean-free paths corresponding to 3-magnon, 4-magnon, and impurity scattering processes. The mean-free paths were calculated using the thermally averaged scattering rates from Section 2.2.2 and are presented in Figure 5.8a. Magnon thermal conductivities calculated for the three samples with different transverse dimensions \( l_0 \) using Eq. 5.2a are in good agreement with the data, providing support that magnon heat conduction is in Poiseuille regime.

Figure 5.8. (a) Magnon mean-free paths for 3-magnon and 4-magnon normal (3N, 4N), umklapp (3U, 4U) processes, elastic impurity scattering (i), and total resistive scattering (R). The Poiseuille conditions are met in the shaded region. (b) \( \kappa_m(T) \) for the three samples from Fig. 5.3. The solid curves are model predictions (Eq. 5.2a). The dashed curve for the \( l_0 = 0.15 \text{ mm} \) specimen represents the spin-wave contribution alone without Poiseuille enhancement. Inset: magnon mean-free paths from the model, normalized by low-T boundary-limited values, for each sample.
5.2.7 Outlook

Due to its record high magnon thermal conductivity, Cu$_2$OSeO$_3$ is a model system for probing long-wavelength magnon dynamics in helical magnets. Studies of magnon heat conduction and magnon-phonon interactions are of great importance in the fields of spin caloritonics [68] and magnon spintronics [69]. Also, thermal magnon currents are important in the field of skyrmion caloritonics because of spin-transfer torques thermal magnons induce on skyrmions [70], providing a means of manipulating skyrmions and domain walls [62], [71], [72] and giving rise to exotic effects such as topological magnon Hall and skyrmion Hall effects [73]. The recent identification of a previously unknown low-T skyrmion phase in Cu$_2$OSeO$_3$ [74] suggests the possibility of observing a magnon thermal Hall effect in this material [75], [76]. Yet another interesting effect has been proposed by Ulloa et. al for magnon dynamics in the Poiseuille regime [77]. Their calculations suggest that a sign change in the non-local spin Seebeck signal in the magnon fluid regime can be observed experimentally.

5.3 Thermal conductivity with magnetic field along [100] and [110]

5.3.1 Overview

In this section we present field-dependent thermal conductivity and magnetization data for several measurement configurations distinguished by the direction of the heat flow and magnetic field. When the field is in the [100] crystallographic direction, magnon thermal conductivity displays sharp features attributed to the transitions into tilted conical and low-temperature skyrmion phases. These features are explained by the effects of domain structure and anisotropic scattering on magnon heat transport. Overall, magnon
thermal conductivity measurements offer a great tool for probing spin-phase transitions and offer new insight into magnon transport in novel magnetic phases.

5.3.2 Thermal conductivity with magnetic field along [110]

Figure 5.9 presents field-dependent thermal conductivity, average temperature, and $dM/dH$ data for two specimens with magnetic field along the [110] crystallographic direction and heat flow perpendicular (a) and parallel (b) to the field. As discussed in Section 5.2.3, changes in thermal conductivity with respect to magnetic field above the field-suppressed (lattice) value can be attributed to changes of the magnon contribution and the sharp increase at the helical-to-conical transition for both orientations corresponds to the disappearance of magnetic domain boundary scattering at the transition from a multidomain to a single domain phase. A smaller upturn in $\kappa$ for the parallel orientation of field and heat current (Fig. 5.9b) suggests the presence of anisotropic magnon-phonon scattering possibly explained by anisotropic magnetoelastic effects or spin-orbit
interactions. Similarly to the [111] case, the behavior of gradual increase of thermal conductivity with the field in the conical phase past the H-C transition and suppression in high field are also observed for these orientations. Notable is the absence of hysteresis.

### 5.3.2 Thermal conductivity with magnetic field along [100]

![Figure 5.10](image)

Figure 5.10. $\kappa(H)/\kappa(0)$, $T_{\text{avg}}$, and $dM/dH$ vs. field at T~2.3 K for heat flow perpendicular (a) and parallel (b) to magnetic field in [100] direction. Helical (H), conical (C), and field polarized (FP) spin phases are distinguished by shading.

The [100] crystallographic direction is favored by cubic anisotropy terms for the orientation of the helical spiral upon cooling in zero field. The competition between anisotropy term and Zeeman terms in applied field is responsible for formations of two new spin phases – tilted conical (TC) and low-temperature skyrmion (LTS) – at low temperatures (see Section 4.2). When the magnetic field is along [100], thermal conductivity displays additional features at fields that coincide with transitions in and out of TC and LTS phases. Figure 5.10 shows $\kappa(H)/\kappa(0)$, $T_{\text{avg}}$, and $dM/dH$ for this orientation of the field and heat flow perpendicular (along [110]) and parallel ([100]) to the direction of the field. The absence of a sharp increase in thermal conductivity at the H-C transition in these orientations can be explained by the conversion of three helical
domains into a single helical domain caused by a small external field in the H phase aligned with the preferred direction of helical modulation. Since there are no domain rotations, the domain wall scattering does not change through the transition.

Figure 5.11. (a) Upper panels: the H > 0 portion of $\kappa$ vs $H$ from Fig. 5.10. Middle panel: SANS intensities for increasing (“up”) and decreasing (“down”) fields (from Ref. [55]) for the TC (solid curves) and LTS (dashed curves) phases. Field values for the SANS data were calibrated against peaks in $dM/dH$. Lower panel: $dM/dH$ from Fig. 5.10b.

Strongly hysteretic features in conical, tilted conical, and low-temperature skyrmion phases are evident. Figure 5.11 displays thermal conductivity for $H > 0$ plotted against SANS intensities and $dM/dH$. SANS intensities form Ref. [55] for tilted conical and low-temperature skyrmion phases determine phase boundaries in the ascending and descending fields and the regions where phases coexist. First, we describe the features that distinguish the two orientations of the heat flow. In ascending field thermal conductivities in the conical phase exhibit opposite behaviors: $\kappa$ for heat flow along [110] increases, while it decreases for heat flow along [100]. Opposite trends are also observed in ascending
field upon the transition into the tilted conical phase: $J_q \parallel [110]$ show a sharp drop, but for $J_q \parallel [100]$ $\kappa$ rapidly grows. Then there are some common features for the two directions of $J_q$. Thermal conductivity keeps growing with ascending field in LTS phase and reaches its maximum value before the transition to the FP phase. In descending field $\kappa$ in the region of TC and LTS phase coexistence is significantly smaller than in the ascending field. The latter features suggest that the domain structure in the region of coexistence of LTS and TC is responsible for significantly higher magnon scattering probabilities compared to the LTS phase and the region of LTS and TC coexistence.

Highly hysteretic behavior of the data in the regions of non-zero LTS intensities is explained by the strongly first-order character of transitions from all other phases to LTS. Topological robustness of the skyrmion lattice is caused by a large energy barrier required for creation of pairs of Bloch points (magnetic monopoles) [56],[57].

Field dependence of thermal conductivity extended to higher fields (Figure 5.11b) reveals that the magnitude of thermal conductivity at the sharp drop caused by the C to TC transition is very close to the field-suppressed (lattice) value. Effectively, upon entering the TC phase magnon heat conduction practically drops to zero. We propose that this is caused by the domain structure in the TC phase that results in highly anisotropic scattering of magnons with momenta transverse to the applied field.

The comparison of field-dependent heat capacity data from Ref. [55] with the thermal conductivity data supports our interpretation of changes of magnon scattering character across the phase boundaries (Figure 5.11c). Magnon mean path, computed using the kinetic theory expression $l_m = 3\kappa_m/C_m v_m$, provides additional insight into characteristic length scales involved in magnon conduction in domain structures of various
spin phases. Notably, the mean free paths in the field polarized phase are equal to the transverse dimension of the sample $l_0$.

### 5.3.3 Outlook

Critical suppression of magnon current at the conical to tilted conical phase boundary might be utilized in the design of a spin current switch, as the observed behavior suggests that the spin currents associated with thermal flow of magnons can be reduced to zero in a very narrow magnetic field range.

Detailed microscopic pictures of domain structures in new exotic chiral spin phases are not well established but might be of great importance for the development of magnonic and skyrmionics memory devices. Magnon currents and associated spin currents provide a mechanism for domain wall manipulation through spin transfer torques, thus fundamental understanding of relevant length scales of magnon transport is crucial in device design.
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Chapter 6. Longitudinal Spin Seebeck Effect in Cu₂OSeO₃

6.1 Overview

Recent theoretical efforts come to a consensus that spin Seebeck effect has its origins in thermal magnon currents [26], [83], suggesting that spin Seebeck is observable in magnetic materials with large magnon thermal conductivities. Rich spin phase diagram accompanied by substantial magnon thermal conductivity in each phase establishes Cu₂OSeO₃ as an excellent candidate for studies of thermal spin transport in chiral phases—a research avenue that has not received a lot of attention, possibly because the majority of chiral magnets are metallic, making it difficult to separate pure spin current effects from spin polarized charge current contributions.

<table>
<thead>
<tr>
<th>#</th>
<th>l (mm)</th>
<th>( \vec{j}_q (\hat{l}) ) direction</th>
<th>w (mm)</th>
<th>( \vec{H} (\hat{w}) ) direction</th>
<th>t (mm)</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>5.00</td>
<td>[111]</td>
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<td>[1(\bar{1})0]</td>
<td>0.26</td>
</tr>
<tr>
<td>2</td>
<td>5.00</td>
<td>[111]</td>
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<td>[1(\bar{1})0]</td>
<td>0.20</td>
</tr>
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<td>[111]</td>
<td>0.75</td>
<td>[1(\bar{1})0]</td>
<td>0.11</td>
</tr>
<tr>
<td>4</td>
<td>0.75</td>
<td>[110]</td>
<td>3.75</td>
<td>[1(\bar{1})0]</td>
<td>1.43</td>
</tr>
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This chapter presents the results of our studies of longitudinal spin Seebeck effect (LSSE) in Cu₂OSeO₃ when heat flow is parallel to the [111] crystallographic direction and magnetic field is along [1\(\bar{1}\)0]. The experimental setup used for the measurements is described in Section 3.4.4. Table 6.1 provides details about the geometries of the samples measured.

We begin the discussion by addressing the concerns of contamination of measured signals by various spurious effects. Next the magnetic field dependence of the spin Seebeck
coefficient $S_{LSSE}$ in the context of various spin phases is discussed. Analysis of
temperature dependence of $S_{LSSE}$ presented next provides insight into relevant length
scales. We conclude by mentioning some interesting effects of surface preparation on
observed spin Seebeck signal and discuss the peculiar effect Joule heating in the platinum
film has on thermal conductivity.

### 6.2 Platinum Film Characterization

![Figure 6.1](image)

Figure 6.1. Field dependence of Hall resistivity of a Pt film on Cu$_2$OSeO$_3$ at 6
temperatures in the range 0.4-10 K. The inset shows the linearity of the data near 0T.

Huang et al. [85] observed effects of proximity magnetization in transport
properties of platinum films deposited on ferromagnetic insulators caused by the proximity
to Stoner instability of Pt. Here we present our results of Pt film characterization in an
attempt to address the concerns of spurious anomalous Nernst effect contaminating LSSE
signal. For a discussion of platinum film preparation procedures refer to Section 3.3.

The resistivity of our 8-10 nm Pt films on Cu$_2$OSeO$_3$ of around 3 $\mu\Omega\text{cm}$ is in good
agreement with literature values for thin films [85]. Figure 6.1 shows magnetic field
dependence of Hall resistivity $\rho_{xy}$ for a Pt film on Cu$_2$OSeO$_3$ (crystal #4) at 6 temperatures in the range 0.4-10 K. Hall resistivities are linear down to zero field and the fits to data pass through the origin – signs that the anomalous Hall effect associated with proximity magnetization effect is not present in Pt/Cu$_2$OSeO$_3$ heterostructures.

Additionally, we analyze the effects of weak localization in the temperature dependence of Pt film resistivity. Figure 6.2a presents temperature dependence of $\frac{\Delta R}{R} = \frac{R - R_{\text{min}}}{R}$. The logarithmic rise is caused by weak localization effects and obeys

$$\frac{\Delta R}{R} = -\frac{e^2}{2\pi^2\hbar} R_{\square}(T_0)\alpha_T \ln\left(\frac{T}{T_0}\right),$$

(6.1)

where $R_{\square}$ is the sheet resistance, $T_0$ is the temperature of resistance minimum, and $\alpha_T$ is the strength of the weak localization effect [86]. The value of $\alpha_T = 0.998$ (Figure 6.2b) is in good agreement with the literature value of $\alpha_T = 1.01 \pm 0.07$.

![Figure 6.2](image_url)

Figure 6.2. (a) Low-T logarithmic-in-T resistance increase for four Pt films. (b) Scaling of $\ln(T)$ resistance rise with sheet resistance.

### 6.3 Magnetic Field Dependence of Spin Seebeck Coefficient

As was discussed in Section 3.4.4, the voltage difference between the two ends of the platinum film $V_{pt}$ is directly measured by a nanovoltmeter. Acquisition of field-
dependent $V_{pt}(H)$ is performed using the following procedure: 1) base temperature and heater power are stabilized at a desired value and kept constant throughout the measurement, 2) $V_{pt}$ is measured at a number of fixed field values from $H = 0$ kOe up to 50 kOe, then down to -50 kOe using the same field setpoints, and back up to zero. Eventually, we discovered that the complete field loop does not produce any significant hysteresis in the voltage signal, so we measured $V_{pt}$ at a series of fixed field values between 50 kOe and -50 kOe (subsequently referred to as “field sweeps”) in either ascending or descending field. For the remainder of the discussion we will focus on experimental data obtained for sample #2, that showed the biggest overall spin Seebeck effect. The results for other samples agree with the discussion presented below qualitatively.

Figure 6.3. (a) Antisymmetric field dependence of $V_{pt}$ for three temperatures. (b) Expanded field scale showing boundaries of helical (H) and conical (C) spin phases.
Figure 6.3a shows $V_{pt}$ vs $H$ data for three selected temperatures. Apparent are the odd symmetry of the signal and a thermal offset at $H = 0$. The expanded field scale in Figure 6.3b reveals sharp asymmetric features of the signal that line up with identified spin phase boundaries.

Further analysis of the data involves the step that eliminates the thermal offset voltage, sample geometry dependence, and temperature gradient dependence.

We calculate the LSSE coefficient $S_{LSSE}$ (Eq. 2.41), a quantity that purely depends on properties of the materials constituting the heterostructure and characteristic parameters describing the interactions at their interface using the equation

$$S_{LSSE} = \frac{V_{pt}(H) - V_{pt}(-H)}{2w} \frac{l_{\Delta T}}{\Delta T}.$$  

(6.1)

Figure 6.4. Field dependence of $S_{LSSE}$ at temperatures between 1 K and 15 K (circles). Signal is absent when the heater is off (squares).
Figure 6.4 shows the spin Seebeck coefficient as a function of magnetic field for several temperatures between 1 K and 15K with the maximum value reaching ~30 µV/K in the collinear phase. Also shown in the figure is the spin Seebeck coefficient when the heater output is zero (squares in Figure 6.4); in this case $S_{LSSE}$ is negligibly small as expected.

![Graphs showing spin Seebeck coefficient and thermal conductivity](image)

Figure 6.5. Field dependence of $S_{LSSE}$ (upper panel) correlated against thermal conductivity (lower panel) for $T = 3.5K$ and 5.7K.

A more fundamental understanding of behavior of spin Seebeck coefficient in field is offered by its comparison with thermal conductivity, simultaneously measured with $S_{LSSE}$. The *in situ* thermal conductivity measurement is one of the advantages the measurement technique in this work offers over conventional LSSE setups (see Section 3.4.4). Figure 6.5 correlates spin Seebeck coefficient against thermal conductivity for $T = 3.5$ and 5.7 K. Despite no observation of suppression of $\kappa$ in high field (magnetic fields on the order of 200 kOe are required to completely depopulate spin waves at presented temperatures), the argument (developed in Section 5.2.3), that changes of thermal conductivity in field can be attributed to changes in the magnon contribution, still applies.
here. This presents us with a great opportunity to analyze correlations between heat and spin currents associated with a thermally driven flow of magnons. Magnon thermal conductivity in the helical phase is finite (~15% of total $\kappa$) and does not change in field. Spin Seebeck effect in the helical phase starts out at zero and gradually increases before making a slight downturn upon approaching the H-C transition.

This difference in behavior can be explained by the absence of net magnetization parallel to the field, required for spin pumping, in the multidomain helical phase, whereas the same magnons are still capable of producing a net flux opposite to the temperature gradient. Gradual rotations of helical domains in increasing small field could result in a net spin current, explaining the rise of $S_{LSSE}$, but seem to have no effect on heat conduction. In the conical phase, as the conical angle decreases in increasing field, a bigger component of precessing magnetization becomes parallel to the field, resulting in more efficient spin pumping. Interestingly, only field sweeps at temperatures below approximately 4 K show prominent features related to the C-FP phase transition. Perhaps, this could be explained by higher thermal fluctuations of spins smearing a clear boundary between low-angle conical and collinear phases (when it comes to the effective component of spin polarization parallel to the field). These thermal fluctuations are then suppressed by the increasing field in the FP phase eventually resulting in saturation of $S_{LSSE}$ at its maximum value, as spins precessing around the direction of the field provide maximum pumping efficiency. Field dependence of spin Seebeck effect in high field closely resembles the behavior of thermal conductivity, and suppression due to magnon depopulation is not observed at these temperatures, though the 0.99 K data in Figure 6.4 appears to show this trend. Generally, acquisition of spin Seebeck data at low temperatures is very challenging, since achievable
temperature differences are strongly limited by the geometric factor of the sample and spin Seebeck voltage becomes rather small and noisy when the gradient is small.

### 6.4 Temperature Dependence of Spin Seebeck Coefficient

#### 6.4.1 Results

Figure 6.6. Temperature dependence of $S_{LSSE}$ at $H = 4.5$ kOe in the FP phase (circles). The peak value of $\sim 30$ µV/K occurs at $T \approx 6$ K. Data is fit with model from Ref. [27].

Figure 6.6 depicts the temperature dependence of spin Seebeck coefficient in the field polarized phase. $S_{LSSE}$ peaks at a value of $\sim 30$ µV/K at $T \approx 6$ K, which is approximately three times bigger than the value of $\sim 9$ µV/K of YIG at its peak ($T \approx 31$ K) [87]. Bulk magnon theory from Ref. [27] described in more detail in Section 2.3 was used to fit the experimental data. Error bars incorporate the uncertainties in the measurement of the temperature gradient, noise levels of the Pt voltage, and temperature instabilities during field sweeps.
6.4.2 Modeling

Magnon dispersion from Ref. [91], fit with $\omega_k = \omega_{ZB}(1 - \cos \pi k/2k_m)$ giving $\omega_{ZB} = 6.9 \times 10^{12} \text{rad/s}, k_m = 1.7 \times 10^9 \text{m}^{-1}$, was used in the calculation (Figure 6.7). Thermally averaged magnon-magnon scattering rates were calculated using Eq. 2.26 and parameters $T_e = 4.2 \text{K}, T_d = 0.004 \text{K}, S = 1, c = 10 \text{ppm}$, and the numeric prefactor for $\tau_{4l}^{-1}$ was increased by 15. Magnon-phonon lifetime was taken to be $\tau_{mp} = 2.5 \times 10^{-7}T^{-3/2} \text{s}$. Other parameters include thickness of platinum film $t_N = 10 \text{nm}$, platinum film resistance $R_N = 120 \Omega$, spin diffusion length in platinum (value for YIG from Ref. [88]) $\lambda_N = 3.7 \text{ nm}$, platinum spin-Hall angle $\theta_{SH} = 0.05$, gyromagnetic ratio $\gamma = 1.82 \times 10^{11} \text{m/As}$ [89], saturation magnetization $4\pi M_s = 1.15 \times 10^5 \text{A/m}$, effective spin mixing conductance $g_{eff} = 9 \times 10^{17} \text{m}^{-2}$, and magnon lifetime of $k = 0$ magnons $\tau_0 = 6.6 \times 10^{-11} \text{s}$.

6.4.3 Comparison with Magnon Thermal Conductivity

Figure 6.8 shows temperature dependencies of spin Seebeck coefficient in the FP phase and magnon thermal conductivity of the $l_0 = 0.6 \text{mm}$ sample from Figure 5.6, separated from the lattice following the procedure outlined in Section 5.2.4. The two
closely correlate, suggesting that thermal magnons and magnons responsible for the pumping of spin current into the platinum film are of similar energy scale, thus providing evidence for thermal magnon origin of spin Seebeck effect in Cu$_2$OSeO$_3$.

![Figure 6.8. Field dependence of $S_{LSSE}$ (orange circles) correlated against magnon thermal conductivity of sample #1 (blue circles).](image)

**6.4.4 Magnon Diffusion Length**

![Figure 6.9. Magnon diffusion length vs temperature.](image)
We have calculated the temperature dependence of magnon diffusion length $l_m$ (Eq. 2.36) using thermally averaged magnon lifetimes. The results displayed in Figure 6.9 show that at 2 K $l_m \approx 3.5 \, \mu m$, compared to $\sim 10 \, \mu m$ for YIG [90]. Though unlikely to be probed by thickness dependent measurements similar to Ref. [93], measurements of non-local spin Seebeck effect might provide additional information about relevant length scales.

6.5 Outlook

In this chapter we presented experimental evidence establishing the presence of spin Seebeck effect in Cu$_2$OSeO$_3$. The unique measurement setup we employed allowed us to gain a lot of insight into the correlations between thermal magnon transport and thermal spin currents responsible for LSSE. More detailed analysis of temperature dependence based on spectral dependencies of magnon-magnon and magnon phonon interactions [94],[95] could contribute to the current discussion of the role of subthermal magnons in spin Seebeck effect [96]-[98]. Although the scope of this work was limited to only one relative orientation of heat flow and magnetic field, our thermal conductivity measurements suggest that further studies of LSSE in other directions will be informative. In addition, exploration of spin Seebeck effect in Cu$_2$OSeO$_3$ in the two skyrmion phases can provide great insight into skyrmion spin transport and its interactions with thermally generated spin excitations and phonons.
REFERENCES


